



Film Capacitors

Metallized Polyester Film Capacitors (MKT)

Series/Type: B32572, B32573

Date: June 2018

© EPCOS AG 2018. Reproduction, publication and dissemination of this publication, enclosures hereto and the information contained therein without EPCOS' prior express consent is prohibited.

EPCOS AG is a TDK Group Company.

Typical applications

- Ignition for gas, engines, generators
- Energy storage

Climatic

- Max. operating temperature: 125 °C
- Climatic category (IEC 60068-1:2013): 55/125/56

Features

- Special dimensions available on request
- High pulse strength
- RoHS-compatible

Construction

- Dielectric: polyethylene terephthalate (polyester, PET)
- Stacked-film technology
- Uncoated

Terminals

- Parallel wire leads, lead-free tinned

Marking

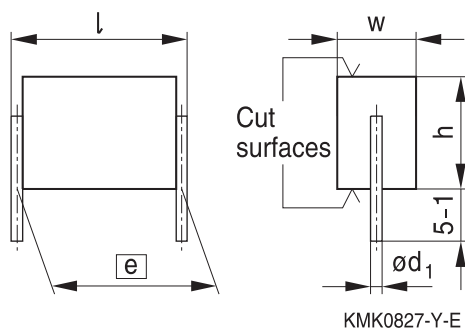
Rated capacitance (coded),
rated DC voltage

Delivery mode

Bulk (untaped)

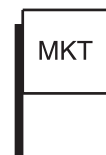
Notes on mounting

When mounting these capacitors, take into account creepage distances and clearances to adjacent live parts. The insulating strength of the cut surfaces to other live parts of the circuit is 1.5 times the capacitors rated DC voltage, but is always at least 300 V DC.

Dimensional drawing


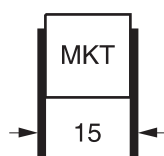
Dimensions in mm

Lead spacing	Lead diameter	Type
$e \pm 0.4$	$d_1 \pm 0.05$	
15.0	0.8	B32572
22.5	0.8	B32573



Overview of available types

Lead spacing	15.0 mm	22.5 mm
Type	B32572	B32573
Page	4	5
V_R (V DC)	250	250
V_{RMS} (V AC)	160	160
C_R (μ F)		
0.68		
1.0		
1.5		
2.2		



B32572

Ignition (stacked) SilverCap™

Ordering codes and packing units (lead spacing 15 mm)

V_R	V_{RMS} $f \leq 60$ Hz	C_R	Max. dimensions $w \times h \times l$ mm	Ordering code (composition see below)	Untaped pcs./MOQ
V DC	V AC	μF			
250	160	0.68	7.0 × 11.0 × 16.5	B32572A3684+000	1800
		1.0	9.1 × 11.7 × 16.5	B32572A3105+000	1200
		1.5	11.5 × 13.5 × 16.5	B32572A3155+000	800
		2.2	11.5 × 19.8 × 16.5	B32572A3225+000	600

MOQ = Minimum Order Quantity, consisting of 4 packing units.
Further E series and intermediate capacitance values on request.

Special dimensions available on request.

For corresponding design rules, refer to chapter "General technical information", section 1.3.2.

Composition of ordering code

+ = Capacitance tolerance code:

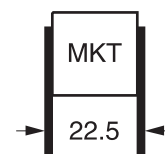
M = ±20%

K = ±10%

J = ±5%

B32573

Ignition (stacked) SilverCap™



Ordering codes and packing units (lead spacing 22.5 mm)

V_R	V_{RMS} $f \leq 60$ Hz	C_R	Max. dimensions $w \times h \times l$	Ordering code (composition see below)	Untaped
V DC	V AC	μF	mm		pcs./MOQ
250	160	0.68	$5.6 \times 9.2 \times 24.0$	B32573A3684+000	4720
		1.0	$6.4 \times 11.8 \times 24.0$	B32573A3105+000	4200
		1.5	$7.6 \times 14.3 \times 24.0$	B32573A3155+000	3720
		2.2	$8.9 \times 17.4 \times 24.0$	B32573A3225+000	2240

MOQ = Minimum Order Quantity, consisting of 4 packing units.
Further E series and intermediate capacitance values on request.

Special dimensions available on request.

For corresponding design rules, refer to chapter "General technical information", section 1.3.2.

Composition of ordering code

+ = Capacitance tolerance code:

M = $\pm 20\%$

K = $\pm 10\%$

J = $\pm 5\%$



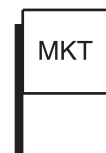
B32572, B32573

Ignition (stacked) SilverCap™

Technical data

Reference standard: IEC 60384-2:2005. All data given at T = 20 °C, unless otherwise specified.

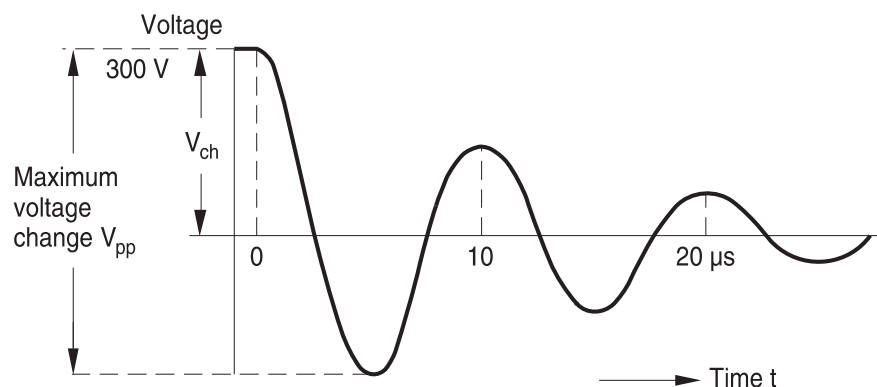
Operating temperature range	Max. operating temperature $T_{op,max}$	+125 °C	
	Upper category temperature T_{max}	+125 °C	
	Lower category temperature T_{min}	-55 °C	
	Rated temperature T_R	+85 °C	
Dissipation factor $\tan \delta$ (in 10^{-3}) at 20 °C (upper limit values)	at	$C_R \leq 1 \mu F$	$C_R > 1 \mu F$
	1 kHz	8	10
	10 kHz	15	—
Time constant $\tau = C_R \cdot R_{ins}$ at 20 °C, rel. humidity $\leq 65\%$ (minimum as-delivered values)	2500 s		
DC test voltage	$1.6 \cdot V_R$, 2 s		
Category voltage V_C (continuous operation with V_{DC} or V_{AC} at $f \leq 60$ Hz)	T_{op} (°C)	DC voltage derating	AC voltage derating
	$T_{op} \leq 85$	$V_C = V_R$	$V_{C,RMS} = V_{RMS}$
	$85 < T_{op} \leq 125$	$V_C = V_R \cdot (165 - T_{op})/80$	$V_{C,RMS} = V_{RMS} \cdot (165 - T_{op})/80$
Max. charging voltage C_{ch}	$1.2 \cdot V_R$ for ≤ 1 s		
Reliability: Failure rate λ Service life t_{SL}	2 fit ($\leq 2 \cdot 10^{-9}/h$) at $0.5 \cdot V_R$, 40 °C 100 000 h at $1.0 \cdot V_R$, 85 °C For conversion to other operating conditions and temperatures, refer to chapter "Quality, 2 Reliability".		
Failure criteria: Total failure Failure due to variation of parameters	Short circuit or open circuit Capacitance change $ \Delta C/C $ > 10% Dissipation factor $\tan \delta$ > 2 · upper limit value Time constant $\tau = C_R \cdot R_{ins}$ < 50 s		



Pulse handling capability

The capacitors are especially manufactured and tested to suit their intended applications.

Typical permissible load:



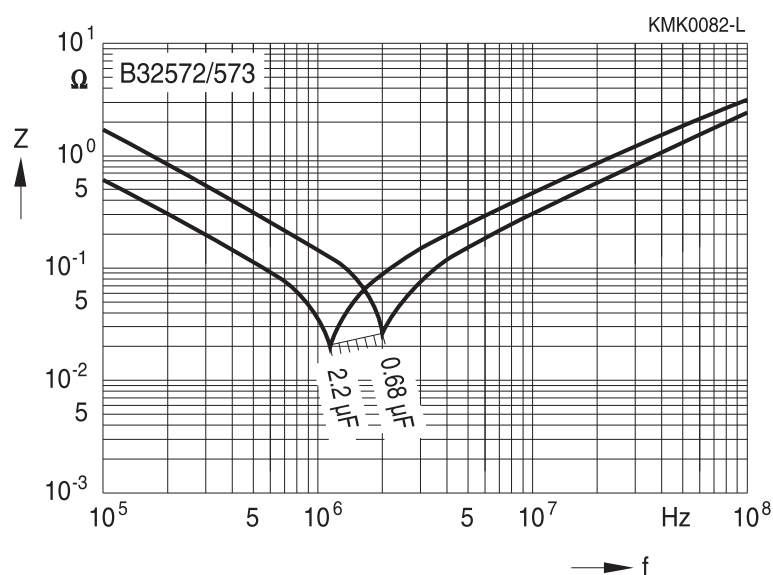
KMK0083-U-E

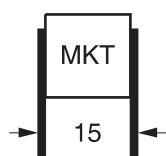
Lead spacing		15 and 22.5 mm
Max. rate of voltage rise V_{pp}/τ	(at $V_{pp} = 500$ V)	200 V/ μs
Pulse characteristic k_0	(at $V_{pp} \leq 500$ V)	200 000 V ² / μs
Max. charging voltage V_{ch}	(≤ 1 s)	300 V DC
Max. voltage change V_{pp}	(at $f = 100$ kHz)	500 V

Unlimited number of pulses permitted.

Impedance Z versus frequency f

(typical values)





B32572

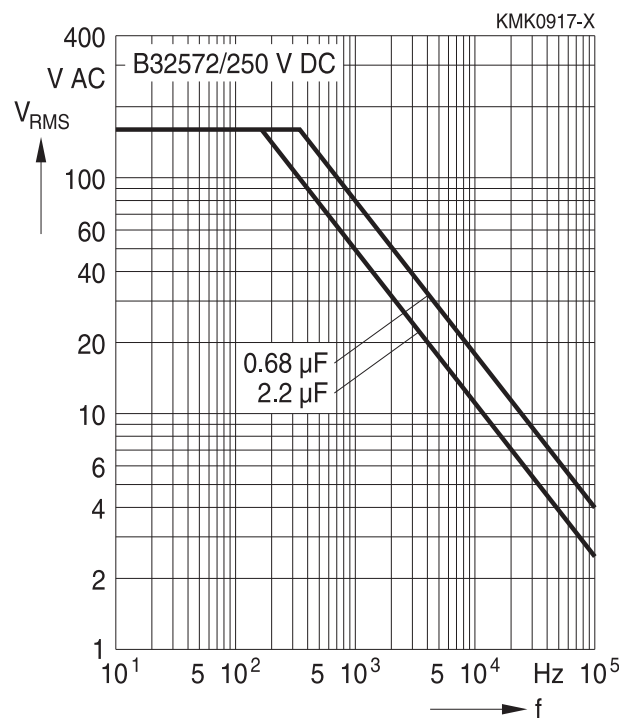
Ignition (stacked) SilverCap™

Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 55^\circ C$)

For $T_A > 55^\circ C$, please refer to "General technical information", section 3.2.3.

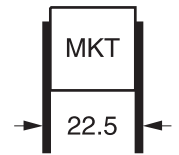
Lead spacing 15 mm

250 V DV/160 V AC



B32573

Ignition (stacked) SilverCap™

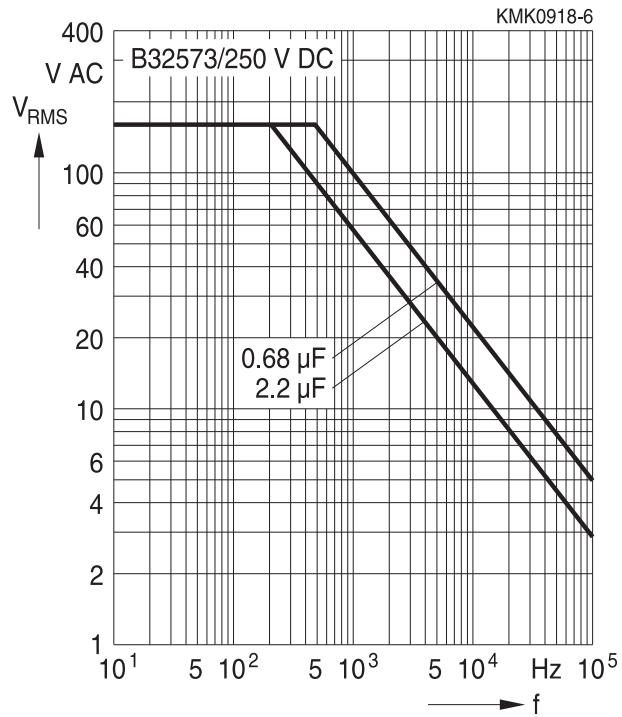


Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 55^\circ C$)

For $T_A > 55^\circ C$, please refer to "General technical information", section 3.2.3.

Lead spacing 22.5 mm

250 V DC/160 V AC





B32572, B32573

Ignition (stacked) SilverCap™

Testing and Standards

Test	Reference	Conditions of test	Performance requirements
Electrical parameters	IEC 60384-2:2005	Voltage proof, $1.4 V_R$, 1 minute Insulation resistance, R_{ins} Capacitance, C Dissipation factor, $\tan \delta$	Within specified limits
Robustness of terminations	IEC 60068-2-21:2006	Tensile strength (test Ua1)	No visible damage Capacitance and $\tan \delta$ within specified limits
		Wire diameter Tensile force $0.5 < d_1 \leq 0.8$ mm 10 N	
Resistance to soldering heat	IEC 60068-2-20:2008, test Tb, method 1A	Solder bath temperature at 260 ± 5 °C, immersion for 4 seconds (lead spacing ≤ 10 mm) 10 seconds (lead spacing > 10 mm)	$\Delta C/C_0 \leq 2\%$ $ \Delta \tan \delta \leq 0.003$ for $C \leq 1 \mu F$ $ \Delta \tan \delta \leq 0.002$ for $C > 1 \mu F$
Rapid change of temperature	IEC 60384-2:2005	T_A = lower category temperature T_B = upper category temperature Five cycles, duration $t = 30$ min.	$\Delta C/C_0 \leq 5\%$ $ \Delta \tan \delta \leq 0.003$ for $C \leq 1 \mu F$ $ \Delta \tan \delta \leq 0.002$ for $C > 1 \mu F$ $R_{ins} \geq 50\%$ of initial limit
Vibration	IEC 60384-2:2005	Test Fc: vibration sinusoidal Displacement: 0.75 mm Acceleration: 98 m/s^2 Frequency: 10 Hz ... 500 Hz Test duration: 3 orthogonal axes, 2 hours each axe	No visible damage
Bump	IEC 60384-2:2005	Test Eb: Total 4000 bumps with 390 m/s^2 mounted on PCB Duration: 6 ms	$\Delta C/C_0 \leq 5\%$ $ \Delta \tan \delta \leq 0.003$ for $C \leq 1 \mu F$ $ \Delta \tan \delta \leq 0.002$ for $C > 1 \mu F$ $R_{ins} \geq 50\%$ of initial limit
Climatic sequence	IEC 60384-2:2005	Dry heat Tb / 16 h Damp heat cyclic, 1 st cycle $+55$ °C / 24 h / 95% ... 100% RH Cold Ta / 2 h Damp heat cyclic, 5 cycles $+55$ °C / 24 h / 95% ... 100% RH	$\Delta C/C_0 \leq 5\%$ $ \Delta \tan \delta \leq 0.005$ for $C \leq 1 \mu F$ $ \Delta \tan \delta \leq 0.003$ for $C > 1 \mu F$ $R_{ins} \geq 50\%$ of initial limit
Damp heat, steady state	IEC 60384-2:2005	Test Ca 40 °C / 93% RH / 56 days	No visible damage $ \Delta C/C_0 \leq 5\%$ $ \Delta \tan \delta \leq 0.005$ $R_{ins} \geq 50\%$ of initial limit

Test	Reference	Conditions of test	Performance requirements
Endurance A	IEC 60384-2:2005	85 °C / 1.25 V _R / 2000 hours	No visible damage $ \Delta C/C_0 \leq 5\%$ $ \Delta \tan \delta \leq 0.003$ for C ≤ 1 μF $ \Delta \tan \delta \leq 0.002$ for C > 1 μF R _{ins} ≥50% of initial limit
Endurance B	IEC 60384-2:2005	125 °C / 1.25 V _C / 2000 hours	No visible damage $ \Delta C/C_0 \leq 5\%$ $ \Delta \tan \delta \leq 0.003$ for C ≤ 1 μF $ \Delta \tan \delta \leq 0.002$ for C > 1 μF R _{ins} ≥50% of initial limit

Mounting guidelines

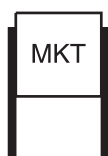
1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder



B32572, B32573

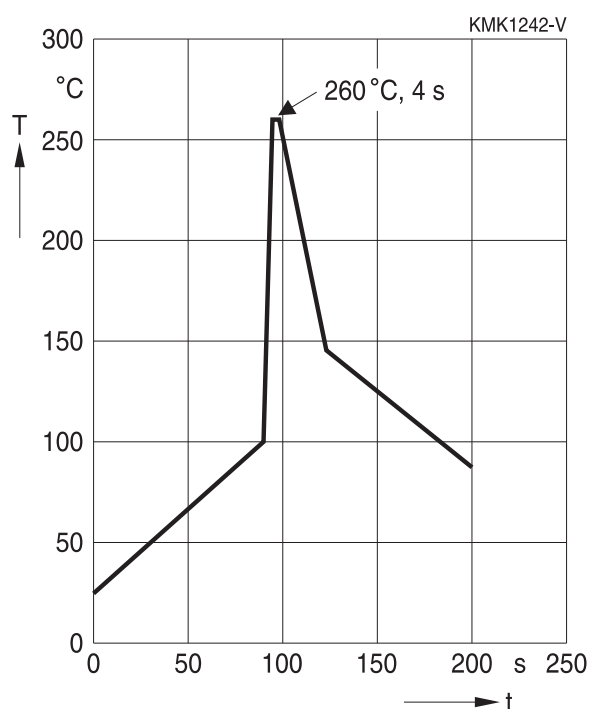
Ignition (stacked) SilverCap™

1.2 Resistance to soldering heat

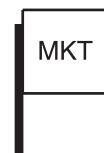
Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1.

Conditions:

Series	Solder bath temperature	Soldering time
MKT boxed (except 2.5 × 6.5 × 7.2 mm) coated uncoated (lead spacing >10 mm)	260 ±5 °C	10 ±1 s
MFP		
MKP (lead spacing >7.5 mm)		
MKT boxed (case 2.5 × 6.5 × 7.2 mm)		5 ±1 s
MKP (lead spacing ≤7.5 mm)		<4 s
MKT uncoated (lead spacing ≤10 mm) insulated (B32559)		recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)



Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 ±0.5) mm thick, between capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors
$\tan \delta$	As specified in sectional specification



1.3 General notes on soldering

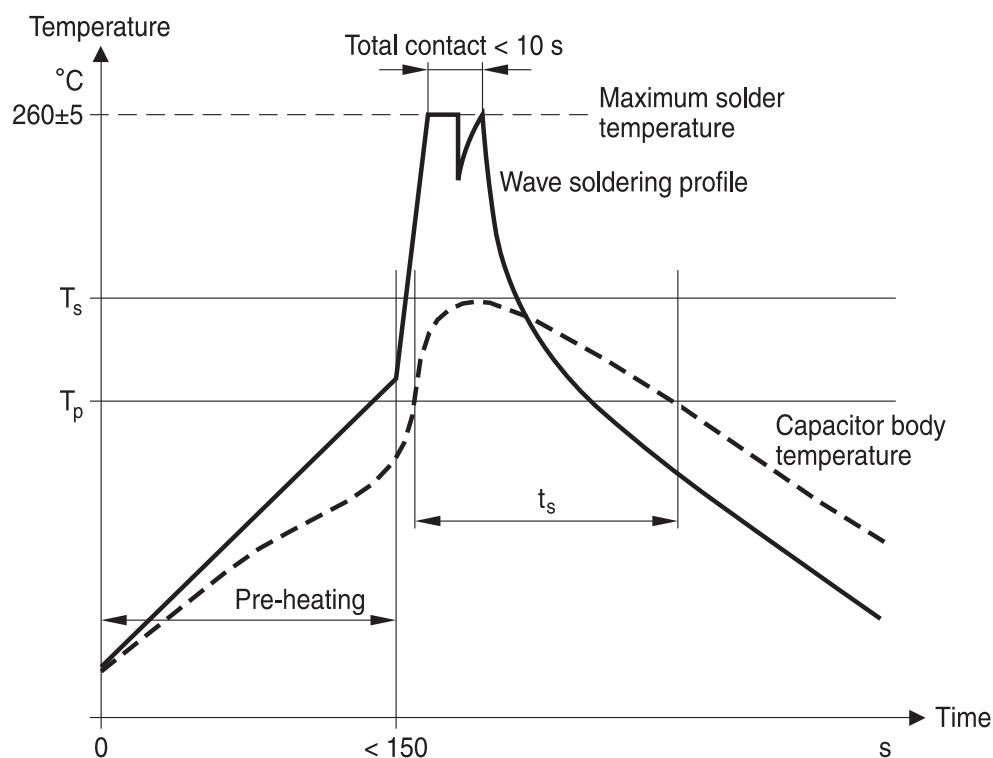
Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommendations

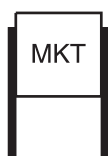
As a reference, the recommended wave soldering profile for our film capacitors is as follows:



T_s : Capacitor body maximum temperature at wave soldering

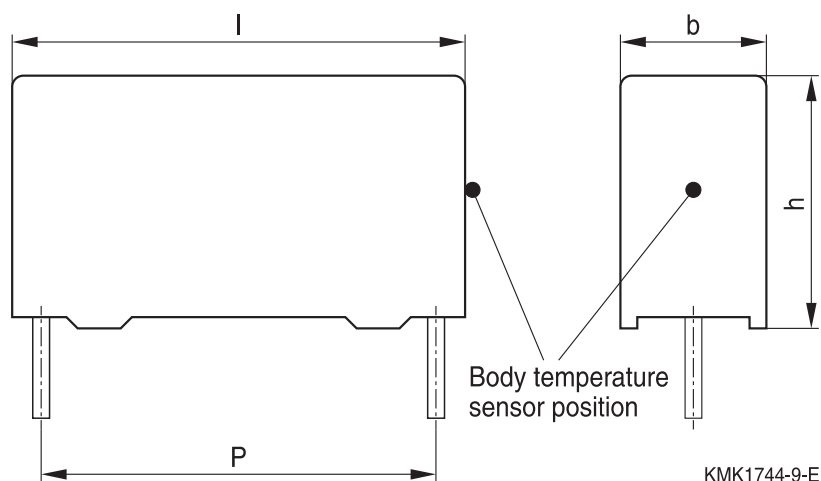
T_p : Capacitor body maximum temperature at pre-heating

KMK1745-A-E



B32572, B32573

Ignition (stacked) SilverCap™



Body temperature should follow the description below:

- MKP capacitor
 - During pre-heating: $T_p \leq 110 \text{ }^\circ\text{C}$
 - During soldering: $T_s \leq 120 \text{ }^\circ\text{C}$, $t_s \leq 45 \text{ s}$
- MKT capacitor
 - During pre-heating: $T_p \leq 125 \text{ }^\circ\text{C}$
 - During soldering: $T_s \leq 160 \text{ }^\circ\text{C}$, $t_s \leq 45 \text{ s}$

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T_s) must be $\leq 120 \text{ }^\circ\text{C}$.

One recommended condition for manual soldering is that the tip of the soldering iron should be $< 360 \text{ }^\circ\text{C}$ and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings $\leq 10 \text{ mm}$ (B32560/B32561) the following measures are recommended:

- pre-heating to not more than $110 \text{ }^\circ\text{C}$ in the preheater phase
- rapid cooling after soldering

Please refer to EPCOS Film Capacitor Data Book in case more details are needed.



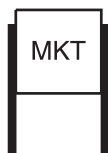
Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of EPCOS.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6:2007. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"

Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"



B32572, B32573

Ignition (stacked) SilverCap™

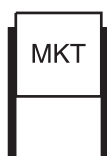
Topic	Safety information	Reference chapter "Mounting guidelines"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.** Detailed information can be found on the Internet under www.epcos.com/orderingcodes.

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_C	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
β_C	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
C	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta \tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f_1	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f_2	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f_r	Resonant frequency	Resonanzfrequenz
F_D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F_T	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I_C	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)



B32572, B32573

Ignition (stacked) SilverCap™

Symbol	English	German
I_{RMS}	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
i_z	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impuls Kennwert
L_S	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_0	Constant failure rate during useful service life	Konstante Ausfallrate in der Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des Entladekreises
R_i	Internal resistance	Innenwiderstand
R_{ins}	Insulation resistance	Isolationswiderstand
R_P	Parallel resistance	Parallelwiderstand
R_S	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
T	Temperature	Temperatur
τ	Time constant	Zeitkonstante
$\tan \delta$	Dissipation factor	Verlustfaktor
$\tan \delta_D$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
$\tan \delta_P$	Parallel component of dissipation factor	Parallelanteil des Verlustfaktors
$\tan \delta_S$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T_A	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
T_{max}	Upper category temperature	Obere Kategorietemperatur
T_{min}	Lower category temperature	Untere Kategorietemperatur
t_{OL}	Operating life at operating temperature and voltage	Betriebszeit bei Betriebstemperatur und -spannung
T_{op}	Operating temperature, $T_A + \Delta T$	Betriebstemperatur, $T_A + \Delta T$
T_R	Rated temperature	Nenntemperatur
T_{ref}	Reference temperature	Referenztemperatur
t_{SL}	Reference service life	Referenz-Lebensdauer

Symbol	English	German
V_{AC}	AC voltage	Wechselspannung
V_C	Category voltage	Kategorie spannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige) Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
V_i	Input voltage	Eingangsspannung
V_o	Output voltage	Ausgangsspannung
V_{op}	Operating voltage	Betriebsspannung
V_p	Peak pulse voltage	Impuls-Spitzen spannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_R	Rated voltage	Nennspannung
\hat{V}_R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage, root-mean-square value	(Sinusförmige) Wechselspannung
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
Z	Impedance	Scheinwiderstand
e	Lead spacing	Rastermaß

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or lifesaving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.epcos.com/material). Should you have any more detailed questions, please contact our sales offices.
5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
6. Unless otherwise agreed in individual contracts, **all orders are subject to the current version of the "General Terms of Delivery for Products and Services in the Electrical Industry" published by the German Electrical and Electronics Industry Association (ZVEI)**.

Important notes

7. **Our manufacturing sites serving the automotive business apply the IATF 16949 standard.** The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements (“CSR”) TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that **only requirements mutually agreed upon can and will be implemented in our Quality Management System.** For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
8. The trade names EPCOS, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, ThermoFuse, WindCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.epcos.com/trademarks.

Release 2018-06

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

EPCOS / TDK:

[B32572A3684K000](#) [B32572A3105K000](#) [B32572A3155K000](#) [B32572A3225K000](#) [B32573A3225K000](#)
[B32572A3684J000](#) [B32573A3105J000](#) [B32573A3155J000](#) [B32572A3225J000](#)

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: ocean@oceanchips.ru

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А